1.0A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER

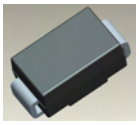
Please click here to visit our online spice models database.

Features

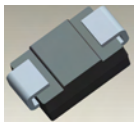
- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 30A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- High Temperature Soldering: 260°C/10 Second at Terminal
- **Lead Free Finish/RoHS Compliant (Note 1)**

Mechanical Data

- Case: SMA / SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 e3
- Polarity: Cathode Band or Cathode Notch
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: SMA 0.064 grams (approximate)
  SMB 0.093 grams (approximate)



Top View



Bottom View

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	B170/B	B180/B	B190/B	B1100/B	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	70	80	90	100	V
RMS Reverse Voltage	$V_{R(RMS)}$	49	56	63	70	V
Average Rectified Output Current @ T_T = 125°C	I_O	1.0				A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	30				A

Thermal Characteristics

Characteristic	Symbol	B170/B	B180/B	B190/B	B1100/B	Unit
Typical Thermal Resistance Junction to Terminal (Note 2)	$R_{\theta JT}$	25				°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150				°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V_F	-	-	0.79 0.69	V	I_F = 1.0A, T_A = 25°C I_F = 1.0A, T_A = 100°C
Leakage Current (Note 3)	I_R	- -	- -	0.5 5.0	mA	@ Rated V_R, T_A = 25°C @ Rated V_R, T_A = 100°C
Total Capacitance	C_T	-	-	80	pF	V_R = 4V, f = 1MHz

Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see *EU Directive 2002/95/EC Annex Notes.*
2. Valid provided that terminals are kept at ambient temperature.
3. Short duration pulse test used to minimize self-heating effect.

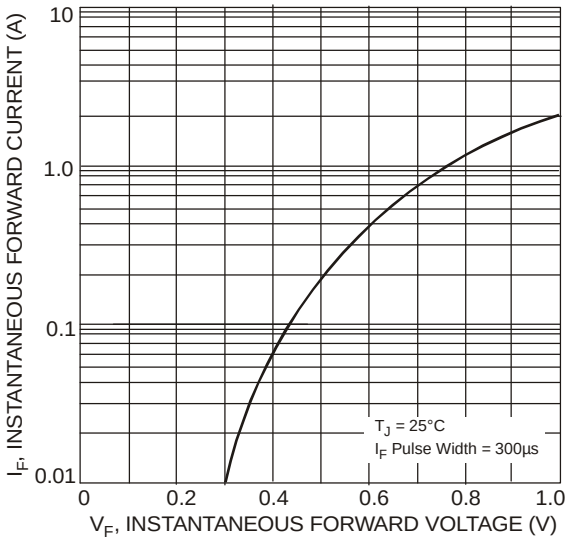


Fig. 1 Typical Forward Characteristics

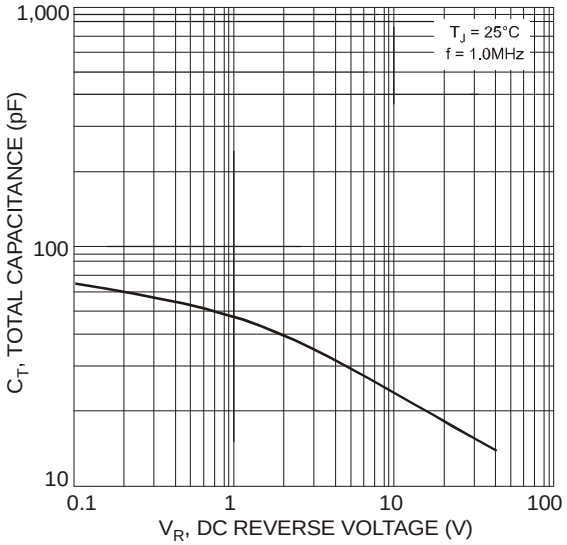


Fig. 2 Total Capacitance vs. Reverse Voltage

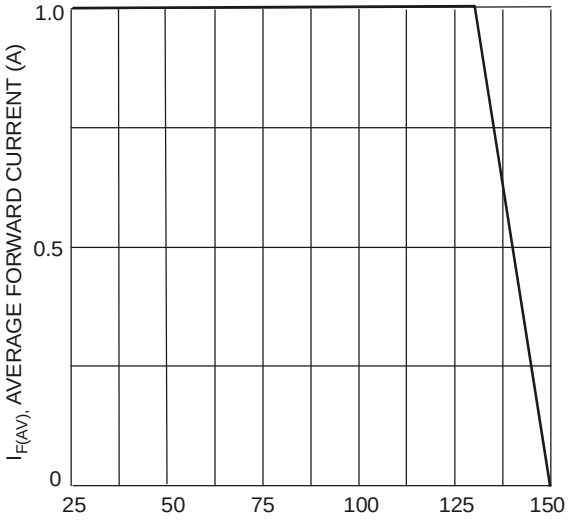


Fig. 3 Forward Current Derating Curve

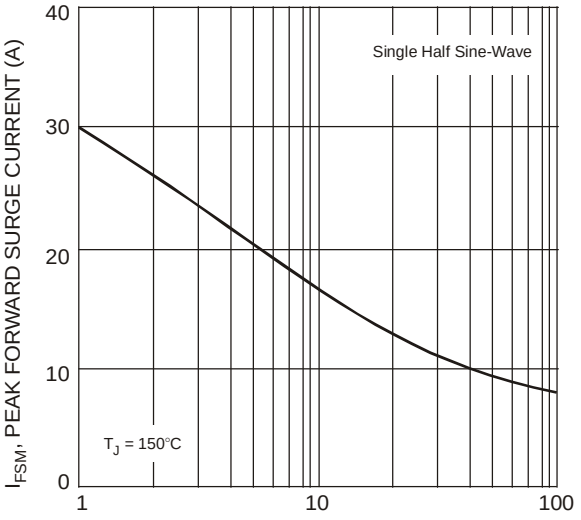


Fig. 4 Max Non-Repetitive Peak Forward Surge Current

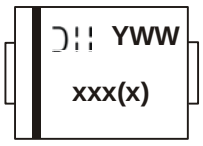
Ordering Information (Note 4)

Part Number	Case	Packaging
B1x-13-F	SMA	5000/Tape & Reel
B1xB-13-F	SMB	3000/Tape & Reel

*x = Device type, e.g. B180-13-F (SMA package); B1100B-13-F (SMB package).

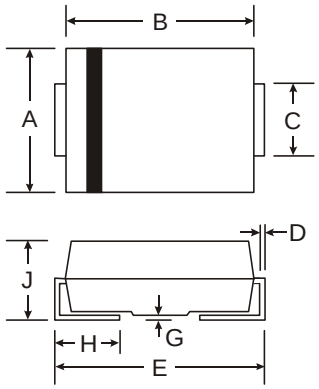
Notes: 4. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



XXX = Product type marking code, ex: B170 (SMA package)
XXXX = Product type marking code, ex: B190B (SMB package)
= Manufacturers' code marking
YWW = Date code marking
Y = Last digit of year ex: 2 for 2002
WW = Week code 01 to 52

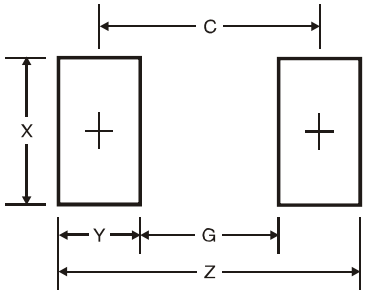
Package Outline Dimensions



SMA		
Dim	**Min**	**Max**
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
H	0.76	1.52
J	2.01	2.30
All Dimensions in mm		

SMB		
Dim	**Min**	**Max**
A	3.30	3.94
B	4.06	4.57
C	1.96	2.21
D	0.15	0.31
E	5.00	5.59
G	0.05	0.20
H	0.76	1.52
J	2.00	2.62
All Dimensions in mm		

Suggested Pad Layout



SMA Dimensions	Value (in mm)
Z	6.5
G	1.5
X	1.7
Y	2.5
C	4.0

SMB Dimensions	Value (in mm)
Z	6.7
G	1.8
X	2.3
Y	2.5
C	4.3